No	tification N	umber	:	20200	625	5005	Notification	Date:	Ju	uly 21, 2020	
Title: Datasheet for TPD2S703-Q1											
Customer Contact: PCN Manager							Dept:		Quality Services		
Change Type:											
						Design			Wafe	r Bump Site	
Ħ				X	Data Sheet				r Bump Material		
Assembly Materials					Part number change			Wafer Bump Process			
	Mechanical Specification			Test Site				r Fab Site			
				Test Process			Wafer Fab Materials				
									Wafer Fab Process		
Notification Details											
Description of Change:											
Texas Instruments Incorporated is announcing an information only notification.  The product datasheet(s) is being updated as summarized below.  The following change history provides further details.											
INSTRUMENTS								TPD2S703-Q1			
								SLLSEU	J8B –MARC	CH 2017-REVISED MAY 2020	
	Changes from Revision A (May 2017) to Revision B  • Changed Figure USB 2.0 Port With Short-to-Battery and IEC ESD Protection image object for clarity										
	Corrected cross reference hyperlink at the ESD Ratings tables										
•	Changed Figure 23 image object for clarity										
•	Added section Common choke and Inductor for VD+ and VD- for clarity									19	
The datasheet number will be changing.											
Device Family					Cha	nge From:		ge To:			
TPD2S703-Q1					SLL	SEU8A		SLLSEU8B			
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/product/TPD2S703-Q1											
Reason for Change:											
To accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.											
Changes to product identification resulting from this notification:											
None.											
Pro	duct Affect	ted:									
TP	D2S703QDGS	RQ1	TPI	D2S7030	QDS	KRQ1					

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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